

MITSUBISHI HVIGBT MODULES  
**CM800DZ-34H**

3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE  
**INSULATED TYPE**

**CM800DZ-34H**



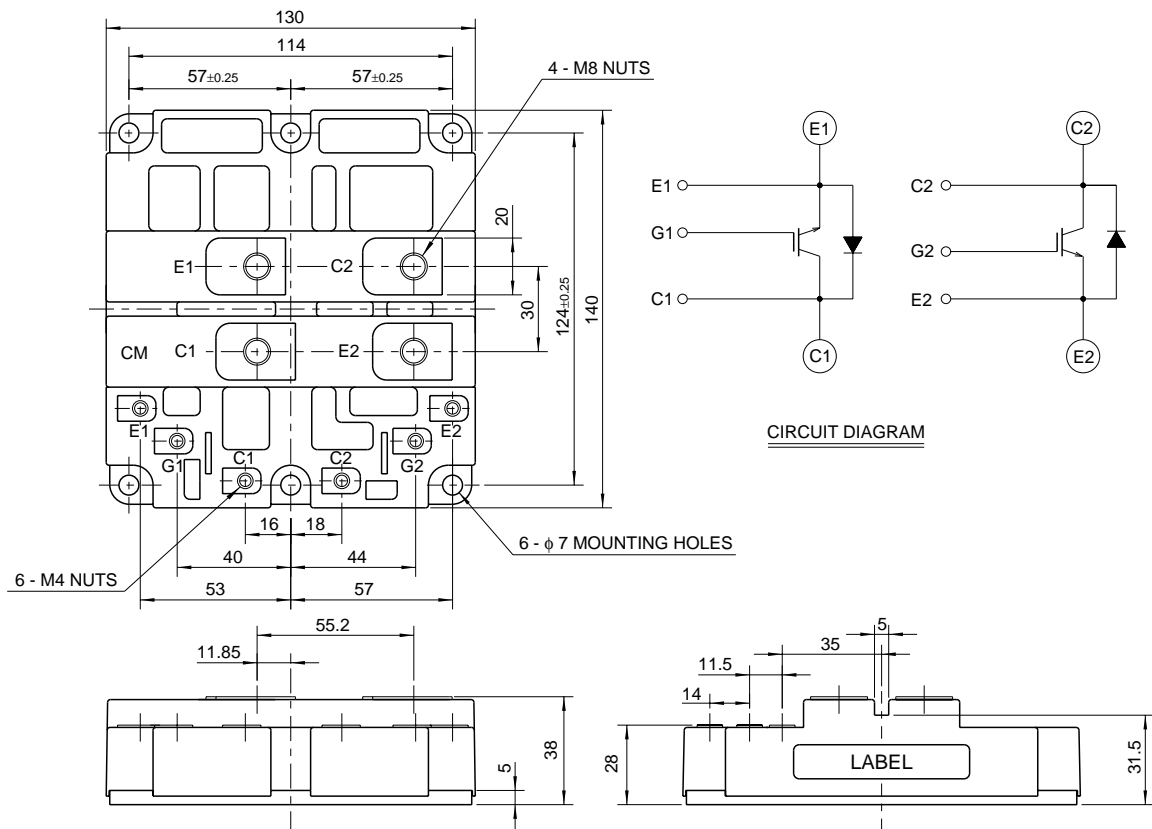
- IC.....800A
- VCES ..... 1700V
- Insulated Type
- 2-elements in a pack

**APPLICATION**

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.

**OUTLINE DRAWING & CIRCUIT DIAGRAM**

Dimensions in mm



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Oct. 2002

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**MAXIMUM RATINGS (T<sub>j</sub> = 25°C)**

Symbol	Item	Conditions	Ratings	Unit
V <sub>CES</sub>	Collector-emitter voltage	V <sub>GE</sub> = 0V	1700	V
V <sub>GES</sub>	Gate-emitter voltage	V <sub>CE</sub> = 0V	±20	V
I <sub>C</sub>	Collector current	T <sub>C</sub> = 25°C	800	A
I <sub>CM</sub>		Pulse (Note 1)	1600	A
I <sub>E</sub> (Note 2)	Emitter current	T <sub>C</sub> = 25°C	800	A
I <sub>EM</sub> (Note 2)		Pulse (Note 1)	1600	A
P <sub>C</sub> (Note 3)	Maximum collector dissipation	T <sub>C</sub> = 25°C, IGBT part	5000	W
T <sub>j</sub>	Junction temperature	—	-40 ~ +150	°C
T <sub>stg</sub>	Storage temperature	—	-40 ~ +125	°C
V <sub>iso</sub>	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1min.	4000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N·m
		Mounting screw M6	2.84 ~ 6.00	N·m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N·m
—	Mass	Typical value	1.0	kg

**ELECTRICAL CHARACTERISTICS (T<sub>j</sub> = 25°C)**

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
I <sub>CES</sub>	Collector cutoff current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V	—	—	12	mA
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	I <sub>C</sub> = 80mA, V <sub>CE</sub> = 10V	4.5	5.5	6.5	V
I <sub>GES</sub>	Gate-leakage current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V	—	—	0.5	μA
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	T <sub>j</sub> = 25°C	—	2.80	3.64	V
		T <sub>j</sub> = 125°C				
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> = 10V V <sub>GE</sub> = 0V	—	72	—	nF
C <sub>oes</sub>	Output capacitance		—	9.0	—	nF
C <sub>res</sub>	Reverse transfer capacitance		—	3.6	—	nF
Q <sub>G</sub>	Total gate charge	V <sub>CC</sub> = 850V, I <sub>C</sub> = 800A, V <sub>GE</sub> = 15V	—	6.6	—	μC
t <sub>d (on)</sub>	Turn-on delay time	V <sub>CC</sub> = 850V, I <sub>C</sub> = 800A	—	—	1.60	μs
t <sub>r</sub>	Turn-on rise time	V <sub>GE1</sub> = V <sub>GE2</sub> = 15V	—	—	2.00	μs
t <sub>d (off)</sub>	Turn-off delay time	R <sub>G</sub> = 3.3Ω	—	—	2.70	μs
t <sub>f</sub>	Turn-off fall time	Resistive load switching operation	—	—	0.80	μs
V <sub>EC</sub> (Note 2)	Emitter-collector voltage	I <sub>E</sub> = 800A, V <sub>GE</sub> = 0V	—	2.60	3.38	V
t <sub>rr</sub> (Note 2)	Reverse recovery time	I <sub>E</sub> = 800A	—	—	2.70	μs
Q <sub>rr</sub> (Note 2)	Reverse recovery charge	die / dt = -1600A / μs	—	150	—	μC
R <sub>th(j-c)Q</sub>	Thermal resistance	Junction to case, IGBT part (Per 1/2 module)	—	—	0.025	K/W
R <sub>th(j-c)R</sub>		Junction to case, FWDi part (Per 1/2 module)	—	—	0.043	K/W
R <sub>th(c-f)</sub>	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/2 module)	—	0.020	—	K/W

- Note 1. Pulse width and repetition rate should be such that the device junction temp. (T<sub>j</sub>) does not exceed T<sub>jmax</sub> rating.  
 2. I<sub>E</sub>, V<sub>EC</sub>, t<sub>rr</sub>, Q<sub>rr</sub> & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.  
 3. Junction temperature (T<sub>j</sub>) should not increase beyond 150°C.  
 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

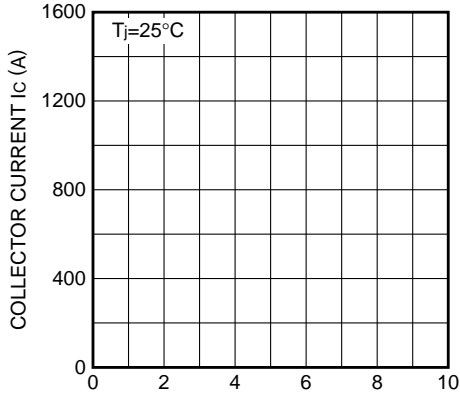
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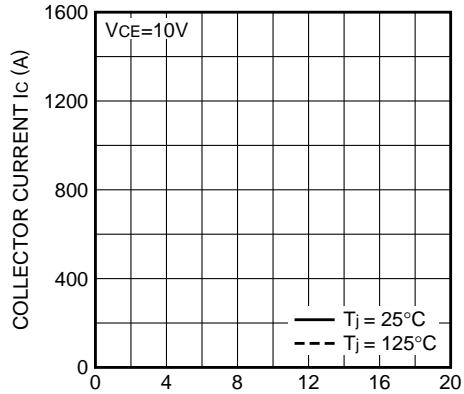
## PERFORMANCE CURVES

OUTPUT CHARACTERISTICS  
(TYPICAL)



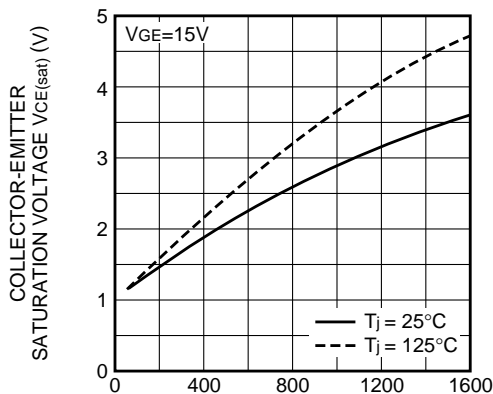
COLLECTOR-EMITTER SATURATION VOLTAGE  $V_{CE(sat)}$  (V)

TRANSFER CHARACTERISTICS  
(TYPICAL)



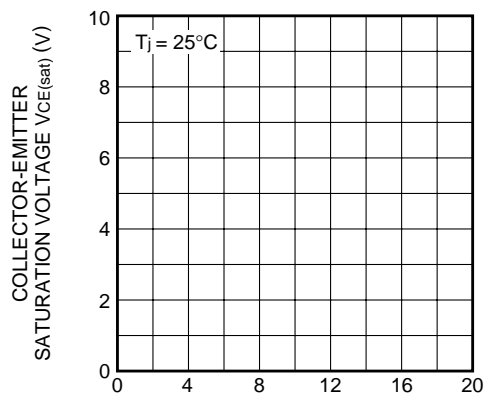
GATE-EMITTER VOLTAGE  $V_{GE}$  (V)

COLLECTOR-EMITTER SATURATION  
VOLTAGE CHARACTERISTICS  
(TYPICAL)



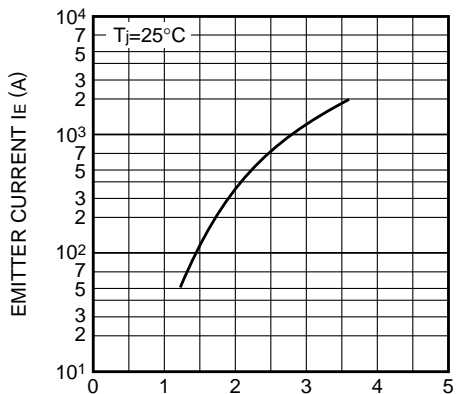
COLLECTOR CURRENT  $I_c$  (A)

COLLECTOR-EMITTER SATURATION  
VOLTAGE CHARACTERISTICS  
(TYPICAL)



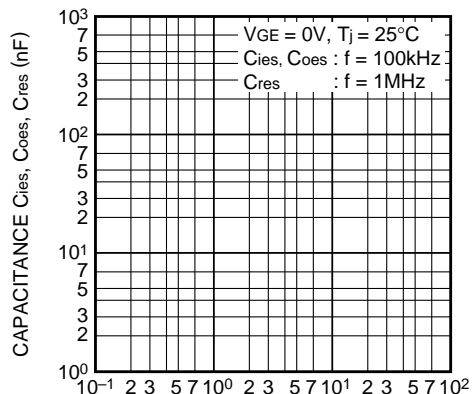
GATE-EMITTER VOLTAGE  $V_{GE}$  (V)

FREE-WHEEL DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL)



EMITTER-COLLECTOR VOLTAGE  $V_{EC}$  (V)

CAPACITANCE VS.  $V_{CE}$   
(TYPICAL)



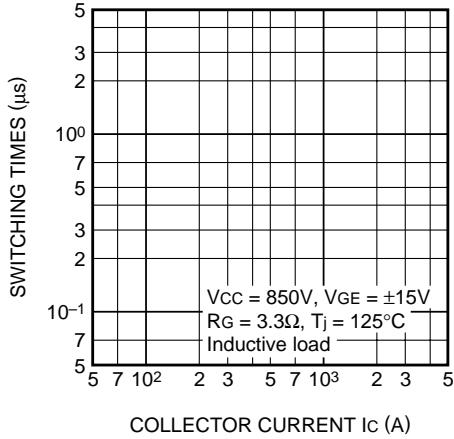
COLLECTOR-EMITTER VOLTAGE  $V_{CE}$  (V)

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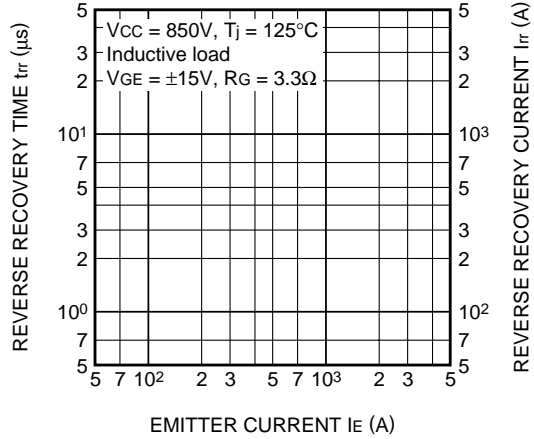
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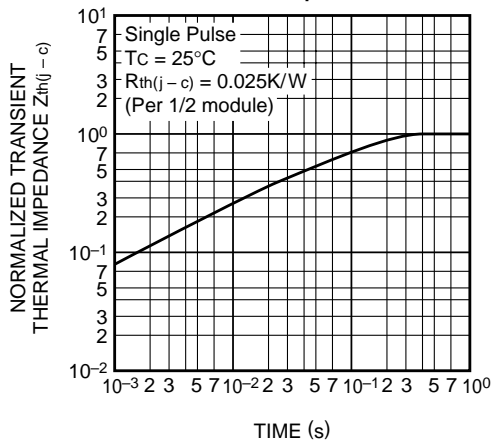
**HALF-BRIDGE  
SWITCHING CHARACTERISTICS  
(TYPICAL)**



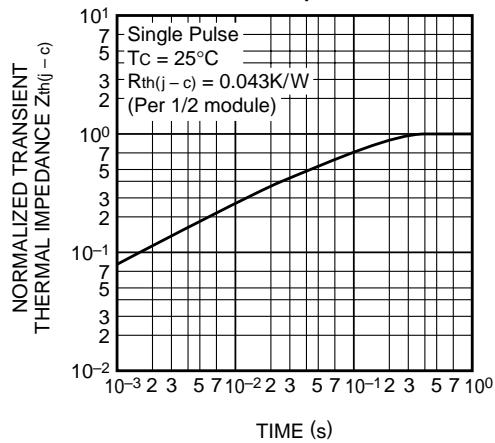
**REVERSE RECOVERY CHARACTERISTICS  
OF FREE-WHEEL DIODE  
(TYPICAL)**



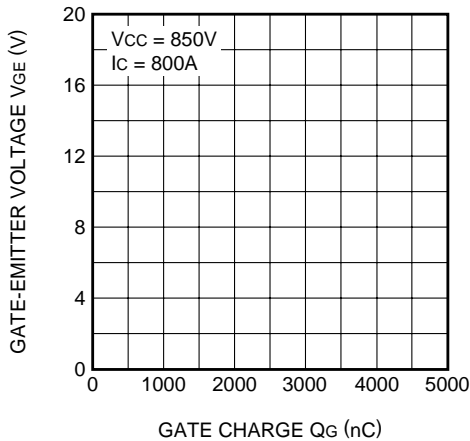
**TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(IGBT part)**



**TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS  
(FWDi part)**



**V<sub>GE</sub> – GATE CHARGE  
(TYPICAL)**



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Datasheets for electronics components.